TOSHIBA Field Effect Transistor Silicon N Channel MOS Type ( $\pi$ -MOSV)

# 2SK2598

Chopper Regulator, DC–DC Converter and Motor Drive Applications

- Low drain-source ON resistance :  $R_{DS (ON)} = 0.18 \Omega$  (typ.)
- High forward transfer admittance : |Y<sub>fs</sub>| = 13 S (typ.)
  - High forward transfer admittance  $|Y_{fs}| = 13 \text{ S} (typ.)$
- Low leakage current :  $I_{DSS} = 100 \ \mu A \ (max) \ (V_{DS} = 250 \ V)$
- Enhancement mode :  $V_{th}$  = 1.5 to 3.5 V ( $V_{DS}$  = 10 V,  $I_D$  = 1 mA)

#### Absolute Maximum Ratings (Ta = 25°C)

Characteris	stics	Symbol	Rating	Unit
Drain-source voltage		V <sub>DSS</sub>	250	V
Drain-gate voltage (R	<sub>GS</sub> = 20 kΩ)	V <sub>DGR</sub>	250	V
Gate-source voltage		V <sub>GSS</sub>	±20	V
Drain current	DC (Note 1)	۱ <sub>D</sub>	13	А
	Pulse (Note 1)	I <sub>DP</sub>	52	A
Drain power dissipation	n (Tc = 25°C)	PD	60	W
Single pulse avalanche	e energy (Note 2)	E <sub>AS</sub>	148	mJ
Avalanche current		I <sub>AR</sub>	13	А
Repetitive avalanche energy (Note 3)		E <sub>AR</sub>	6	mJ
Channel temperature		T <sub>ch</sub>	150	°C
Storage temperature ra	ange	T <sub>stg</sub>	−55 to 150	°C

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

#### **Thermal Characteristics**

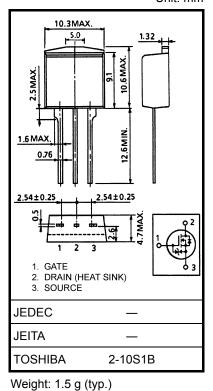
Characteristics	Symbol	Max	Unit
Thermal resistance, channel to case	R <sub>th (ch−c)</sub>	2.08	°C / W
Thermal resistance, channel to ambient	R <sub>th (ch−a)</sub>	83.3	°C / W

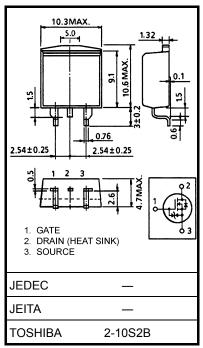
Note 1: Ensure that the channel temperature does not exceed 150°C.

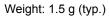
Note 2:  $V_{DD}$  = 50 V,  $T_{ch}$  = 25°C (initial), L = 1.48 mH,  $R_G$  = 25  $\Omega$ ,  $I_{AR}$  = 13 A

Note 3: Repetitive rating: pulse width limited by maximum channel temperature

This transistor is an electrostatic-sensitive device. Please handle with caution.







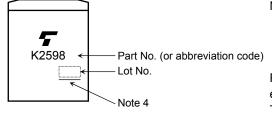
**Electrical Characteristics (Ta = 25°C)** 

Charao	cteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cu	eakage current $I_{GSS}$ $V_{GS}$ = ±16 V, $V_{DS}$ = 0 V		_	_	±10	μA	
Drain cut-off cu	rrent	I <sub>DSS</sub>	V <sub>DS</sub> = 250 V, V <sub>GS</sub> = 0 V		_	100	μA
Drain-source breakdown voltage		V (BR) DSS	I <sub>D</sub> = 10 mA, V <sub>GS</sub> = 0 V		_		V
Gate threshold	voltage	V <sub>th</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 1 mA	1.5	_	3.5	V
Drain-source O	N resistance	R <sub>DS (ON)</sub>	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 6.5 A		0.18	0.25	Ω
Forward transfe	r admittance	Y <sub>fs</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 6.5 A	6	13		S
Input capacitance	pacitance C <sub>iss</sub>				1800		pF
Reverse transfer capacitance		C <sub>rss</sub>	V <sub>DS</sub> = 10 V, V <sub>GS</sub> = 0 V, f = 1 MHz		130		
Output capacitance		Coss			500		
Switching time	Rise time	tr	$V_{GS} \stackrel{10 \text{ V}}{}_{0 \text{ V}} \stackrel{I_{D} = 6.5 \text{ A}}{\underset{\overset{\scriptstyle \circ}{\overset{\scriptstyle \circ}}{\overset{\scriptstyle \circ}{\overset{\scriptstyle \circ}{\overset{\scriptstyle \circ}{\overset{\scriptstyle \circ}{\overset{\scriptstyle \circ}{\overset{\scriptstyle \circ}}{\overset{\scriptstyle \circ}{\overset{\scriptstyle \circ}{\overset{\scriptstyle \circ}{\overset{\scriptstyle \circ}{\overset{\scriptstyle \circ}{\overset{\scriptstyle \circ}{\overset{\scriptstyle \circ}{\overset{\scriptstyle \circ}}{\overset{\scriptstyle \circ}{\overset{\scriptstyle \circ}{\overset{\scriptstyle \circ}{\overset{\scriptstyle \circ}}{\overset{\scriptstyle \circ}{\overset{\scriptstyle \circ}}{\overset{\scriptstyle \circ}{\overset{\scriptstyle \circ}{\overset{\scriptstyle \circ}}{\overset{\scriptstyle \circ}{\overset{\scriptstyle \circ}{\overset{\scriptstyle \circ}}{\overset{\scriptstyle \circ}{\overset{\scriptstyle \circ}}{\overset{\scriptstyle \circ}{\overset{\scriptstyle \circ}}{\overset{\scriptstyle \circ}}{\overset{\scriptstyle \circ}{\overset{\scriptstyle \circ}}{\overset{\scriptstyle \circ}{\overset{\scriptstyle \circ}}}{\overset{\scriptstyle \circ}}{\overset{\scriptstyle \circ}}{\overset{\scriptstyle \circ}}{\overset{\scriptstyle \circ}}{\overset{\scriptstyle \circ}}{\overset{\scriptstyle \circ}}}}}}}}}}} $	_	15	_	- ns
	Turn-on time	t <sub>on</sub>		_	25	_	
	Fall time	t <sub>f</sub>		_	10	_	
	Turn-off time	t <sub>off</sub>	Duty $\leq 1\%$ , t <sub>w</sub> = 10 µs	_	70	_	
Total gate charge (Gate-source plus gate-drain)		Qg		_	40	_	nC
Gate-source charge		Q <sub>gs</sub>	V <sub>DD</sub> ≈ 200 V, V <sub>GS</sub> = 10 V, I <sub>D</sub> = 13 A	_	25	_	
Gate-drain ("miller") charge		Q <sub>gd</sub>	]		15	_	

#### Source–Drain Ratings and Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current (Note 1)	I <sub>DR</sub>	—	_	_	13	А
Pulse drain reverse current (Note 1)	I <sub>DRP</sub>	_	—	-	52	A
Forward voltage (diode)	V <sub>DSF</sub>	I <sub>DR</sub> = 13 A, V <sub>GS</sub> = 0 V	_	_	-2.0	V
Reverse recovery time	t <sub>rr</sub>	I <sub>DR</sub> = 13 A, V <sub>GS</sub> = 0 V	_	260	_	ns
Reverse recovery charge	Qrr	dI <sub>DR</sub> / dt = 100 A / µs	_	0.3		μC

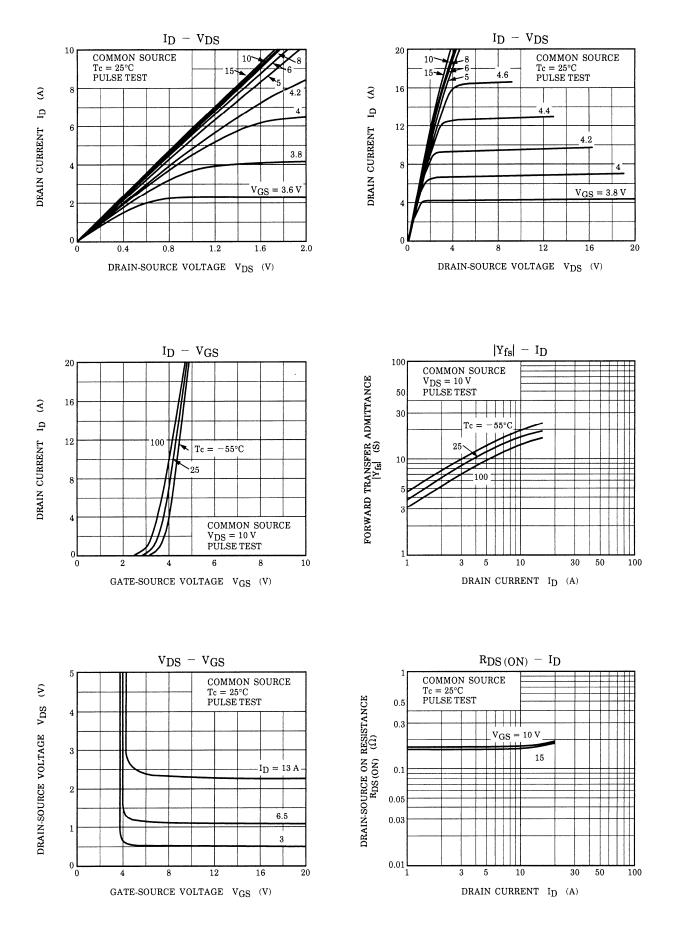
#### Marking



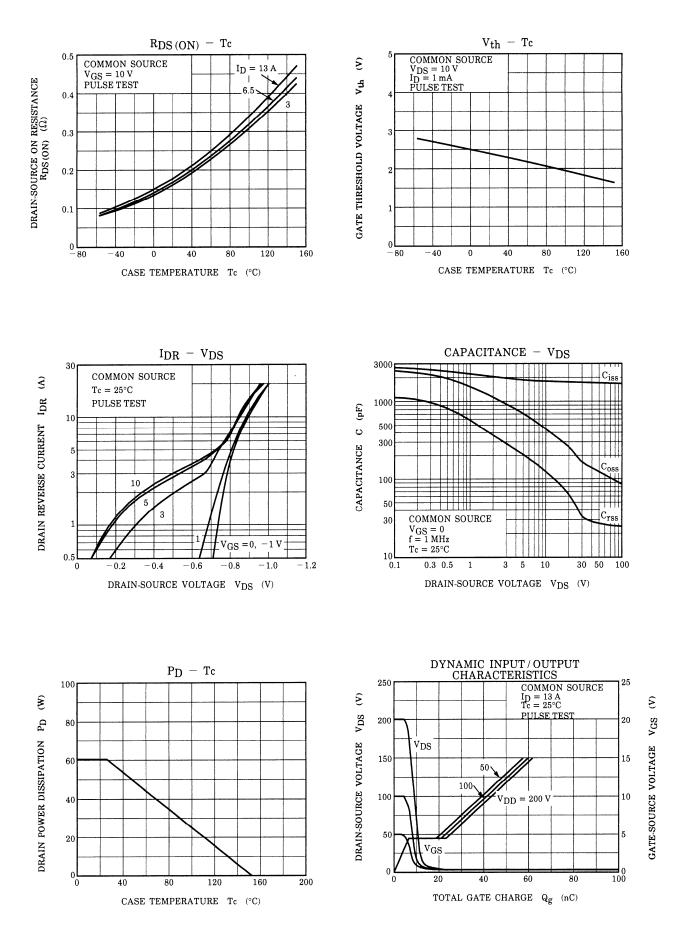
Note 4: A line under a Lot No. identifies the indication of product Labels. Not underlined: [[Pb]]/INCLUDES > MCV Underlined: [[G]]/RoHS COMPATIBLE or [[G]]/RoHS [[Pb]] Please contact your TOSHIBA sales representative for details as to

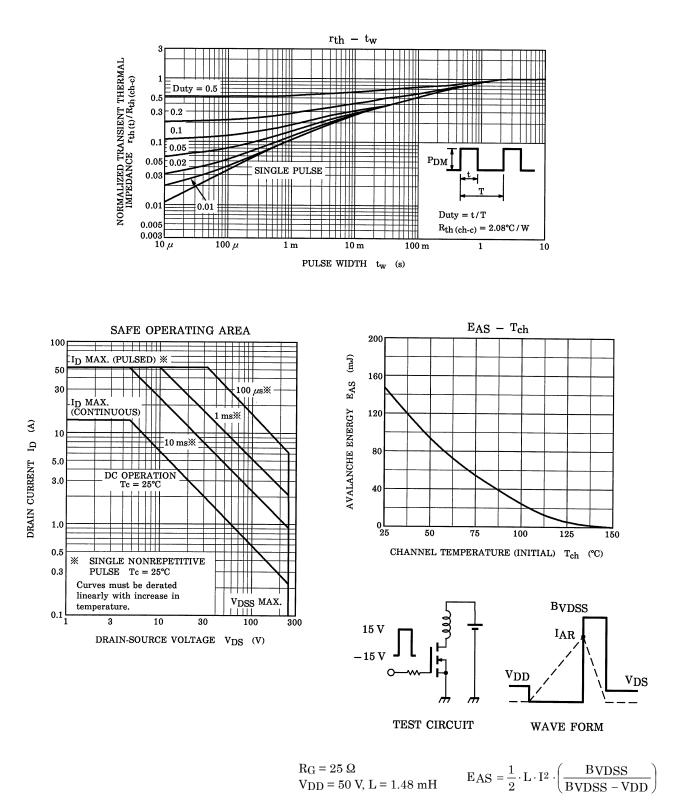
environmental matters such as the RoHS compatibility of Product. The RoHS is the Directive 2002/95/EC of the European Parliament and of the Council of 27 January 2003 on the restriction of the use of certain hazardous substances in electrical and electronic equipment.

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